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Product Description

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Table 1. PIN DESCRIPTIONS

Pin	Name	Description

CM1411

PERFORMANCE INFORMATION

CM1411

MECHANICAL CASE OUTLINE

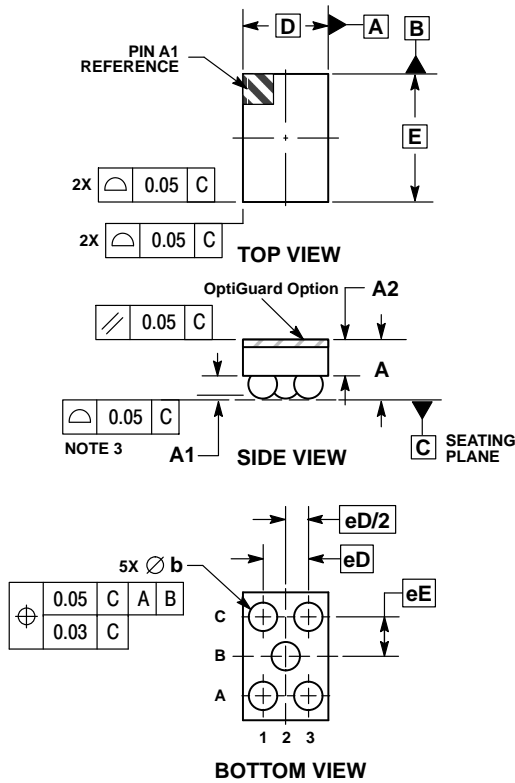
PACKAGE DIMENSIONS



SCALE 4:1

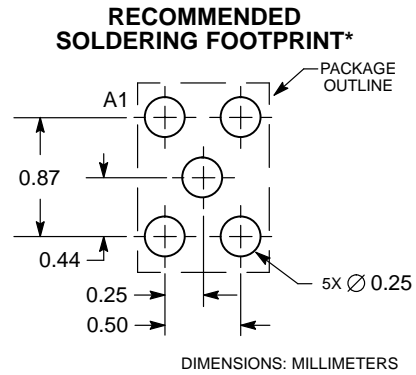
WLCSP5, 0.94x1.41
CASE 567AZ-01
ISSUE O

DATE 26 JUL 2010



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.

DIM	MILLIMETERS	
	MIN	MAX
A	0.56	0.72
A1	0.21	0.27
A2	0.40 REF	
b	0.29	0.35
D	0.94 BSC	
E	1.41 BSC	
eD	0.50 BSC	
eE	0.435 BSC	



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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